## FEATURES

Fast throughput rate: 1.5 MSPS
Specified for VDD of 2.7 V to 5.25 V
Low power
8 mW max at 1.5 MSPS with 3 V supplies
16 mW max at 1.5 MSPS with 5 V supplies
8 analog input channels with a sequencer
Software configurable analog inputs
8-channel single-ended inputs
4-channel fully differential inputs
4-channel pseudo-differential inputs
7-channel pseudo-differential inputs
Accurate on-chip 2.5 V reference
Wide input bandwidth
70 dB SNR at $\mathbf{5 0} \mathbf{~ k H z}$ input frequency
No pipeline delays
High speed parallel interface-word/byte modes
Full shutdown mode: $1 \mu \mathrm{~A}$ max
32-lead LFCSP and TQFP package

## GENERAL DESCRIPTION

The AD7938/AD7939 are 12-bit and 10-bit, high speed, low power, successive approximation (SAR) ADCs. The parts operate from a single 2.7 V to 5.25 V power supply and feature throughput rates up to 1.5 MSPS. The parts contain a low noise, wide bandwidth, differential track-and-hold amplifier that can handle input frequencies up to 20 MHz .

The AD7938/AD7939 feature eight analog input channels with a channel sequencer that allow a preprogrammed selection of channels to be converted sequentially. These parts can operate with either single-ended, fully differential, or pseudodifferential analog inputs.

The conversion process and data acquisition are controlled using standard control inputs that allow easy interfacing with microprocessors and DSPs. The input signal is sampled on the falling edge of CONVST and the conversion is also initiated at this point.

The AD7938/AD7939 have an accurate on-chip 2.5 V reference that can be used as the reference source for the analog-to-digital

[^0] registered trademarks are the property of their respective owners.

FUNCTIONAL BLOCK DIAGRAM


Figure 1.
conversion. Alternatively, this pin can be overdriven to provide an external reference.

These parts use advanced design techniques to achieve very low power dissipation at high throughput rates. They also feature flexible power management options. An on-chip control register allows the user to set up different operating conditions, including analog input range and configuration, output coding, power management, and channel sequencing.

## PRODUCT HIGHLIGHTS

1. High throughput with low power consumption.
2. Eight analog inputs with a channel sequencer.
3. Accurate on-chip 2.5 V reference.
4. Software configurable analog inputs. Single-ended, pseudodifferential, or fully differential analog inputs that are software selectable.
5. Single-supply operation with $V_{\text {drive }}$ function. The $V_{\text {drive }}$ function allows the parallel interface to connect directly to 3 V , or 5 V processor systems independent of $\mathrm{V}_{\mathrm{DD}}$.
6. No pipeline delay.
7. Accurate control of the sampling instant via a $\overline{\text { CONVST }}$ input and once off conversion control.
[^1]
## AD7938/AD7939

## TABLE OF CONTENTS

AD7938-Specifications .....  3
AD7939—Specifications ..... 5
Timing Specifications .....  7
Absolute Maximum Ratings .....  8
ESD Caution .....  8
Pin Function Description ..... 9
Terminology ..... 11
Typical Performance Characteristics ..... 13
On-Chip Registers ..... 16
Circuit Information ..... 18
Converter Operation ..... 18
ADC Transfer Function ..... 18
Typical Connection Diagram ..... 19
Analog Input Structure ..... 19
Analog Inputs. ..... 20
Analog Input Selection ..... 22
Reference Section ..... 23
Parallel Interface ..... 25
Power Modes of Operation ..... 28
Power vs. Throughput Rate ..... 29
Microprocessor Interfacing ..... 29
Application Hints ..... 31
Grounding and Layout ..... 31
PCB Design Guidelines for Chip Scale Package ..... 31
Evaluating the AD7938/AD7939 Performance ..... 31
Outline Dimensions ..... 32
Ordering Guide ..... 32

## REVISION HISTORY

## 8/04-Revision PrN: Preliminary Version

## AD7938-SPECIFICATIONS

$\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\text {DRIVE }}=2.7 \mathrm{~V}$ to 5.25 V , Internal/External $\mathrm{V}_{\text {ReF }}=2.5 \mathrm{~V}$, unless otherwise noted, $\mathrm{F}_{\text {CLKIN }}=24 \mathrm{MHz}, \mathrm{F}_{\text {SAMPLE }}=1.5 \mathrm{MSPS} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted.

Table 1.

| Parameter | B Version ${ }^{1}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Signal-to-Noise + Distortion (SINAD) ${ }^{2}$ <br> Signal-to-Noise Ratio (SNR) ${ }^{2}$ <br> Total Harmonic Distortion (THD) ${ }^{2}$ <br> Peak Harmonic or Spurious Noise (SFDR) ${ }^{2}$ <br> Intermodulation Distortion (IMD) ${ }^{2}$ <br> Second-Order Terms <br> Third-Order Terms <br> Channel to Channel Isolation <br> Aperture Delay ${ }^{2}$ <br> Aperture Jitter ${ }^{2}$ <br> Full Power Bandwidth ${ }^{2,3}$ | $\begin{aligned} & 70 \\ & 70 \\ & -75 \\ & -75 \\ & -85 \\ & -85 \\ & -85 \\ & 5 \\ & 50 \\ & 20 \\ & 2.5 \end{aligned}$ | dB min $d B$ min dB max dB max <br> dB typ dB typ dB typ ns typ ps typ <br> MHz typ <br> MHz typ | $\mathrm{F}_{\mathrm{IN}}=50 \mathrm{kHz}$ sine wave $\begin{aligned} & -80 \mathrm{~dB} \text { typ } \\ & -82 \mathrm{~dB} \text { typ } \\ & \mathrm{fa}=40.1 \mathrm{kHz}, \mathrm{fb}=51.5 \mathrm{kHz} \end{aligned}$ <br> @ 3 dB <br> @ 0.1 dB |
| DC ACCURACY <br> Resolution <br> Integral Nonlinearity ${ }^{2}$ <br> Differential Nonlinearity ${ }^{2}$ <br> Total Unadjusted Error <br> Single-Ended and Pseudo-Differential Input <br> Offset Error ${ }^{2}$ <br> Offset Error Match ${ }^{2}$ <br> Gain Error ${ }^{2}$ <br> Gain Error Match ${ }^{2}$ <br> Fully Differential Input <br> Positive Gain Error ${ }^{2}$ <br> Positive Gain Error Match ${ }^{2}$ <br> Zero-Code Error ${ }^{2}$ <br> Zero-Code Error Match ${ }^{2}$ <br> Negative Gain Error ${ }^{2}$ <br> Negative Gain Error Match ${ }^{2}$ | 12 <br> $\pm 1$ <br> $\pm 0.95$ <br> TBD <br> $\pm 4.5$ <br> $\pm 0.5$ <br> $\pm 2$ <br> $\pm 0.6$ <br> $\pm 2$ <br> $\pm 0.6$ <br> $\pm 3$ <br> $\pm 1$ <br> $\pm 2$ <br> $\pm 0.6$ | Bits LSB max LSB max LSB max <br> LSB max LSB max LSB max LSB max <br> LSB max LSB max LSB max LSB max LSB max LSB max | Guaranteed no missed codes to 12 bits <br> Straight binary output coding <br> Twos complement output coding |
| ANALOG INPUT <br> Single-Ended Input Range <br> Pseudo-Differential Input Range: $\mathrm{V}_{\mathbb{N}+}$ <br> $\mathrm{V}_{\mathrm{IN}-}$ <br> Fully Differential Input Range: $\mathrm{V}_{\mathbb{N}+}$ and $\mathrm{V}_{\mathbb{I N}-}$ $\mathrm{V}_{\mathrm{IN}+}$ and $\mathrm{V}_{\mathrm{IN}-}$ <br> DC Leakage Current ${ }^{5}$ <br> Input Capacitance | $\begin{aligned} & 0 \text { to } V_{\text {REF }} \text { or } 0 \text { to } 2 \times V_{\text {REF }} \\ & 0 \text { to } V_{\text {REF }} \text { or } 2 \times V_{\text {REF }} \\ & -0.1 \text { to }+0.4 \\ & V_{\text {CM }} \pm V_{\text {REF }} / 2 \\ & V_{\text {CM }} \pm V_{\text {REF }} \\ & \pm 1 \\ & 45 \\ & 10 \end{aligned}$ | V <br> V <br> V <br> V <br> V <br> $\mu \mathrm{A}$ max <br> pF typ <br> pF typ | Depending on RANGE bit setting <br> Depending on RANGE bit setting <br> $\mathrm{V}_{\mathrm{CM}}=$ common-mode voltage ${ }^{4}=\mathrm{V}_{\text {REF }} / 2$ <br> $\mathrm{V}_{\mathrm{CM}}=\mathrm{V}_{\mathrm{REF}}, \mathrm{V}_{\mathbb{I N}^{+}}$or $\mathrm{V}_{\mathbb{I N}-}$ must remain within $G N D / V_{D D}$ <br> When in track <br> When in hold |
| REFERENCE INPUT/OUTPUT <br> $V_{\text {REF }}$ Input Voltage ${ }^{6}$ <br> DC Leakage Current <br> $V_{\text {REF }}$ Input Impedance <br> $V_{\text {ReFout }}$ Output Voltage <br> $V_{\text {Refout }}$ Temperature Coefficient <br> $V_{\text {ReF }}$ Noise | $\begin{aligned} & 2.5 \\ & \pm 1 \\ & 10 \\ & 2.5 \\ & 15 \\ & 10 \\ & 130 \end{aligned}$ | V <br> $\mu \mathrm{A}$ max <br> k $\Omega$ typ <br> V <br> ppm $/{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V}$ typ <br> $\mu \mathrm{V}$ typ | $\pm 1 \%$ for specified performance <br> $\pm 0.1 \%$ @ $25^{\circ} \mathrm{C}$ <br> 0.1 Hz to 10 Hz bandwidth <br> 0.1 Hz to 1 MHz bandwidth |


| Parameter | B Version ${ }^{1}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $V_{\text {REF }}$ Output Impedance $V_{\text {REF }}$ Input Capacitance | $\begin{aligned} & 10 \\ & 15 \\ & 25 \end{aligned}$ | $\Omega$ typ pF typ pF typ | When in track When in hold |
| LOGIC INPUTS Input High Voltage, $\mathrm{V}_{\mathrm{INH}}$ Input Low Voltage, VinL Input Current, In Input Capacitance, $\mathrm{CliN}^{5}$ | $\begin{gathered} 2.4 \\ 0.8 \\ \pm 1 \\ 10 \end{gathered}$ | $\checkmark$ min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | Typically $10 \mathrm{nA}, \mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ |
| LOGIC OUTPUTS <br> Output High Voltage, Vон <br> Output Low Voltage, Vo <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{5}$ Output Coding | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \pm 10 \\ & 10 \end{aligned}$ <br> Straight (Natura) <br> Twos Complem | $\vee$ min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & \text { ISOURCE }=200 \mu \mathrm{~A} \\ & \text { IsINk }^{2} 200 \mu \mathrm{~A} \\ & \\ & \text { CODING bit }=0 \\ & \text { CODING bit }=1 \end{aligned}$ |
| CONVERSION RATE <br> Conversion Time <br> Track-and-Hold Acquisition Time Throughput Rate | $\begin{aligned} & \mathrm{t}_{2}+13 \mathrm{t}_{\mathrm{clk}}+\mathrm{t}_{20} \\ & 135 \\ & 1.5 \end{aligned}$ | ns <br> ns max MSPS max | Full-scale step input |
| POWER REQUIREMENTS |  |  |  |
| $V_{\text {D }}$ | 2.7/5.25 | $\checkmark$ min/max |  |
| V drive | 2.7/5.25 | $\checkmark$ min/max |  |
| $1 \mathrm{ld}{ }^{7}$ |  |  | Digital I/Ps $=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ |
| Normal Mode(Static) | 0.5 | mA typ | $V_{\text {DD }}=2.7 \mathrm{~V}$ to 5.25 V, SCLK on or off |
| Normal Mode (Operational) | $\begin{aligned} & 3.2 \\ & 2.6 \end{aligned}$ | mA max <br> mA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=2.7 \mathrm{~V} \text { to } 3.6 \mathrm{~V} \end{aligned}$ |
| Auto-Standby Mode | $\begin{aligned} & 1.55 \\ & 90 \end{aligned}$ | mA typ <br> $\mu \mathrm{A}$ max | $\mathrm{F}_{\text {SAMPLE }}=250 \mathrm{kSPS}$ <br> (Static) |
| Auto-Shutdown Mode | $\begin{aligned} & 1 \\ & 1 \end{aligned}$ | mA typ $\mu \mathrm{A}$ max | Fsample $=250 \mathrm{kSPS}$ <br> (Static) |
| Full Shutdown Mode Power Dissipation | 1 | $\mu \mathrm{A}$ max | SCLK on or off |
| Normal Mode (Operational) | $\begin{aligned} & 16 \\ & 8 \end{aligned}$ | mW max <br> mW max | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=3 \mathrm{~V} \end{aligned}$ |
| Auto-Standby Mode (Static) | $\begin{aligned} & 450 \\ & 270 \end{aligned}$ | $\mu \mathrm{W}$ max $\mu \mathrm{W}$ max | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=3 \mathrm{~V} \end{aligned}$ |
| Auto-Shutdown Mode (Static) | $\begin{aligned} & 5 \\ & 3 \end{aligned}$ | $\mu \mathrm{W}$ max $\mu \mathrm{W}$ max | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=3 \mathrm{~V} \end{aligned}$ |
| Full Shutdown Mode | 5/3 | $\mu \mathrm{W}$ max | $V_{D D}=5 \mathrm{~V} / 3 \mathrm{~V}$ |

[^2]
## AD7939—SPECIFICATIONS

$\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\text {DRIVE }}=2.7 \mathrm{~V}$ to 5.25 V , Internal/External $\mathrm{V}_{\text {ReF }}=2.5 \mathrm{~V}$, unless otherwise noted, $\mathrm{F}_{\text {CLKIN }}=24 \mathrm{MHz}, \mathrm{F}_{\text {SAMPLE }}=1.5 \mathrm{MSPS} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted.

Table 2.

| Parameter | B Version ${ }^{1}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Signal-to-Noise + Distortion (SINAD) ${ }^{2}$ <br> Signal-to-Noise Ratio (SNR) ${ }^{2}$ <br> Total Harmonic Distortion (THD) ${ }^{2}$ <br> Peak Harmonic or Spurious Noise (SFDR) ${ }^{2}$ <br> Intermodulation Distortion (IMD) ${ }^{2}$ <br> Second-Order Terms <br> Third-Order Terms <br> Channel to Channel Isolation <br> Aperture Delay ${ }^{2}$ <br> Aperture Jitter ${ }^{2}$ <br> Full Power Bandwidth ${ }^{2,3}$ | $\begin{aligned} & 60 \\ & 60 \\ & -73 \\ & -73 \\ & -75 \\ & -75 \\ & -75 \\ & 5 \\ & 50 \\ & 20 \\ & 2.5 \end{aligned}$ | dB min dB min dB max dB max <br> dB typ dB typ dB typ ns typ ps typ <br> MHz typ <br> MHz typ | $\mathrm{F}_{\mathrm{IN}}=50 \mathrm{kHz}$ sine wave $\mathrm{fa}=40.1 \mathrm{kHz}, \mathrm{fb}=51.5 \mathrm{kHz}$ <br> @ 3 dB <br> @ 0.1 dB |
| DC ACCURACY <br> Resolution <br> Integral Nonlinearity ${ }^{2}$ <br> Differential Nonlinearity ${ }^{2}$ <br> Total Unadjusted Error <br> Single-Ended and Pseudo-Differential Input <br> Offset Error ${ }^{2}$ <br> Offset Error Match ${ }^{2}$ <br> Gain Error ${ }^{2}$ <br> Gain Error Match ${ }^{2}$ <br> Fully Differential Input <br> Positive Gain Error ${ }^{2}$ <br> Positive Gain Error Match ${ }^{2}$ <br> Zero-Code Error ${ }^{2}$ <br> Zero-Code Error Match ${ }^{2}$ <br> Negative Gain Error ${ }^{2}$ <br> Negative Gain Error Match ${ }^{2}$ | 10 <br> $\pm 0.5$ <br> $\pm 0.5$ <br> TBD <br> $\pm 4.5$ <br> $\pm 0.5$ <br> $\pm 2$ <br> $\pm 0.6$ <br> $\pm 2$ <br> $\pm 0.6$ <br> $\pm 3$ <br> $\pm 1$ <br> $\pm 2$ <br> $\pm 0.6$ | Bits <br> LSB max LSB max LSB max <br> LSB max LSB max LSB max LSB max <br> LSB max LSB max LSB max LSB max LSB max LSB max | Guaranteed no missed codes to 10 bits <br> Straight binary output coding <br> Twos complement output coding |
| ANALOG INPUT <br> Single-Ended Input Range <br> Pseudo-Differential Input Range: $\mathrm{V}^{1 N_{+}}$ <br> $\mathrm{V}_{\text {IN- }}$ <br> Fully Differential Input Range: $\mathrm{V}_{\mathbb{N}+}$ and $\mathrm{V}_{\mathbb{1 N}-}$ $\mathrm{V}_{\mathrm{IN}+}$ and $\mathrm{V}_{\mathrm{IN}_{-}}$ <br> DC Leakage Current ${ }^{5}$ <br> Input Capacitance | $\begin{aligned} & 0 \text { to } V_{\text {REF }} \text { or } 0 \text { to } 2 \times V_{\text {REF }} \\ & 0 \text { to } V_{\text {REF }} \text { or } 2 \times V_{\text {REF }} \\ & -0.1 \text { to }+0.4 \\ & V_{\text {CM }} \pm V_{\text {REF }} / 2 \\ & V_{C M} \pm V_{\text {REF }} \\ & \pm 1 \\ & 45 \end{aligned}$ | V <br> V <br> V <br> V <br> V <br> $\mu \mathrm{A}$ max <br> pF typ | Depending on RANGE bit setting <br> Depending on RANGE bit setting <br> $\mathrm{V}_{\text {CM }}=$ common-mode voltage ${ }^{4}=\mathrm{V}_{\text {REF }} / 2$ <br> $V_{C M}=V_{\text {REF }}, V_{I_{N}+}$ or $V_{\text {IN }}$ must remain within $G N D / V_{D D}$ <br> When in track |
|  | 10 | pF typ | When in hold |
| REFERENCE INPUT/OUTPUT <br> $V_{\text {REF }}$ Input Voltage ${ }^{6}$ <br> DC Leakage Current ${ }^{5}$ <br> $V_{\text {REF }}$ Input Impedance <br> $V_{\text {Refout }}$ Output Voltage <br> $V_{\text {Refout }}$ Temperature Coefficient <br> $V_{\text {REF }}$ Noise | $\begin{aligned} & 2.5 \\ & \pm 1 \\ & 10 \\ & 2.5 \\ & 15 \\ & 10 \\ & 130 \\ & \hline \end{aligned}$ | V <br> $\mu \mathrm{A}$ max <br> $\mathrm{k} \Omega$ <br> V <br> ppm $/{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V}$ typ <br> $\mu \mathrm{V}$ typ | $\pm 1 \%$ for specified performance $\pm 0.1 \% @ 25^{\circ} \mathrm{C}$ <br> 0.1 Hz to 10 Hz bandwidth <br> 0.1 Hz to 1 MHz bandwidth |


| Parameter | B Version ${ }^{1}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $V_{\text {ReF }}$ Output Impedance $V_{\text {REF }}$ Input Capacitance | $\begin{aligned} & 10 \\ & 15 \\ & 25 \end{aligned}$ | $\Omega$ typ pF typ pF typ | When in track When in hold |
| LOGIC INPUTS <br> Input High Voltage, $\mathrm{V}_{\mathrm{INH}}$ <br> Input Low Voltage, VinL <br> Input Current, In <br> Input Capacitance, $\mathrm{CliN}^{5}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 1 \\ & 10 \end{aligned}$ | $V$ min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | Typically $10 \mathrm{nA}, \mathrm{V}_{\mathbb{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ |
| LOGIC OUTPUTS <br> Output High Voltage, Vон <br> Output Low Voltage, Vol <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{5}$ Output Coding | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \pm 10 \\ & 10 \end{aligned}$ <br> Straight (Natur Twos Complem | $\vee$ min <br> $V$ max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & \text { Isource }=200 \mu \mathrm{~A} ; \\ & \text { IsINK }=200 \mu \mathrm{~A} \end{aligned}$ <br> CODING bit $=0$ CODING bit =1 |
| CONVERSION RATE <br> Conversion Time <br> Track-and-Hold Acquisition Time Throughput Rate | $\begin{aligned} & \mathrm{t}_{2}+13 \mathrm{t}_{\mathrm{clk}}+\mathrm{t}_{20} \\ & 135 \\ & 1.5 \end{aligned}$ | ns ns max MSPS max | Full-scale step input |
| POWER REQUIREMENTS |  |  |  |
| $V_{\text {D }}$ | 2.7/5.25 | V min/max |  |
| $V_{\text {drive }}$ | 2.7/5.25 | $\checkmark \min /$ max |  |
| $1 \mathrm{ld}{ }^{7}$ |  |  | Digital I/Ps $=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ |
| Normal Mode(Static) | 0.5 | mA typ | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{SCLK}$ on or off |
| Normal Mode (Operational) | 3.2 | mA max | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to 5.25 V |
|  | 2.6 | mA max | $V_{D D}=2.7 \mathrm{~V}$ to 3.6 V |
| Auto-Standby Mode |  | mA typ $\mu \mathrm{A}$ max | $\mathrm{F}_{\text {SAMPLE }}=250 \mathrm{kSPS}$ <br> (Static) |
| Auto-Shutdown Mode | 1 | mA typ $\mu \mathrm{A}$ max | Fsample $=250 \mathrm{kSPS}$ <br> (Static) |
| Power Dissipation Normal Mode (Operational) | 1 | $\mu \mathrm{A}$ max | SCLK on or off |
|  | 16 | $m W$ max | $V_{D D}=5 \mathrm{~V}$ |
|  | 8 | $m W$ max | $V_{D D}=3 \mathrm{~V}$ |
| Auto-Standby Mode (Static) | 450 | $\mu \mathrm{W}$ max | $V_{D D}=5 \mathrm{~V}$ |
|  | 270 | $\mu \mathrm{W}$ max | $V_{D D}=3 \mathrm{~V}$ |
| Auto-Shutdown Mode (Static) | 5 | $\mu \mathrm{W}$ max | $V_{D D}=5 \mathrm{~V}$ |
|  | 3 | $\mu \mathrm{W}$ max | $V_{D D}=3 \mathrm{~V}$ |
| Full Shutdown Mode | 5 | $\mu \mathrm{W}$ max | $V_{D D}=5 \mathrm{~V}$ |
|  | 3 | $\mu \mathrm{W}$ max | $V_{D D}=3 \mathrm{~V}$ |

[^3]
## TIMING SPECIFICATIONS ${ }^{1}$

$\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\text {DRIVE }}=2.7 \mathrm{~V}$ to 5.25 V , Internal/External $\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$, unless otherwise noted, $\mathrm{F}_{\text {clikin }}=24 \mathrm{MHz}, \mathrm{F}_{\text {SAMPLe }}=1.5 \mathrm{MSPS} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted.

Table 3.

| Parameter | Limit at $\mathrm{T}_{\text {min, }} \mathrm{T}_{\text {max }}$ |  | Unit | Description |
| :---: | :---: | :---: | :---: | :---: |
|  | AD7938 | AD7939 |  |  |
| $\mathrm{fcKkIN}^{2}$ | 10 | 10 | $\begin{aligned} & \mathrm{kHz} \\ & \mathrm{~min} \end{aligned}$ |  |
|  | 24 | 24 | MHz <br> max |  |
| $\mathrm{t}_{\text {Quiet }}$ | 10 | 10 | ns min | Minimum time between end of Read and start of next conversion (i.e., time from when the data bus goes into three-state until the next falling edge of $\overline{\text { CONVST }}$ ) |
| $\mathrm{t}_{1}$ | 10 | 10 | ns min | $\overline{\text { CONVST Pulse Width. }}$ |
| $\mathrm{t}_{2}$ | 20 | 20 | ns min | $\overline{\text { CONVST }}$ Falling Edge to CLKIN Falling Edge Setup Time. |
| $\mathrm{t}_{3}$ | TBD | TBD | ns min | CLKIN Falling Edge to BUSY Rising Edge. |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Setup Time. |
| $\mathrm{t}_{5}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Hold Time. |
| $\mathrm{t}_{6}$ | 25 | 25 | ns min | $\overline{\text { WR Pulse Width. }}$ |
| $\mathrm{t}_{7}$ | 10 | 10 | ns min | Data Setup Time before $\overline{W R}$. |
| $\mathrm{t}_{8}$ | 5 | 5 | ns min | Data Hold after $\overline{W R}$. |
| $\mathrm{t}_{9}$ | 0.5 tcLikin | 0.5 tclıkin | ns min | New Data Valid before Falling Edge of BUSY. |
| $\mathrm{t}_{10}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time. |
| $\mathrm{t}_{11}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time. |
| $\mathrm{t}_{12}$ | 55 | 55 | ns min | $\overline{\mathrm{RD}}$ Pulse Width. |
| $\mathrm{t}_{13}{ }^{3}$ | 50 | 50 | ns max | Data Access Time after $\overline{\mathrm{RD}}$. |
| $\mathrm{t}_{14}{ }^{4}$ | 5 | 5 | ns min | Bus Relinquish Time after $\overline{\mathrm{RD}}$. |
|  | 40 | 40 | ns max | Bus Relinquish Time after $\overline{\mathrm{RD}}$. |
| $\mathrm{t}_{15}$ | 15 | 15 | ns min | HBEN to $\overline{\mathrm{RD}}$ Setup Time. |
| $\mathrm{t}_{16}$ | 5 | 5 | ns min | HBEN to $\overline{\mathrm{RD}}$ Hold Time. |
| $\mathrm{t}_{17}$ | 10 | 10 | ns min | Minimum Time between Reads/Writes. |
| $\mathrm{t}_{18}$ | 0 | 0 | ns min | HBEN to $\overline{W R}$ Setup Time. |
| $\mathrm{t}_{19}$ | 5 | 5 | ns min | HBEN to $\overline{W R}$ Hold Time. |
| $\mathrm{t}_{20}$ | TBD | TBD | ns max | CLKIN Falling Edge to BUSY Falling Edge. |

[^4]
## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.
Table 4.

| Parameter | Rating |
| :---: | :---: |
| $V_{\text {DD }}$ to AGND/DGND | -0.3 V to +7 V |
| V ${ }_{\text {drive }}$ to AGND/DGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Analog Input Voltage to AGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Input Voltage to DGND | -0.3 V to 7 V |
| $V_{\text {drive }}$ to $V_{\text {dD }}$ | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to DGND | -0.3 V to $\mathrm{V}_{\text {drie }}+0.3 \mathrm{~V}$ |
| $V_{\text {Refin }}$ to AGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| AGND to DGND | -0.3 V to +0.3 V |
| Input Current to Any Pin Except Supplies ${ }^{1}$ | $\pm 10 \mathrm{~mA}$ |
| Operating Temperature Range |  |
| Commercial (B Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ Thermal Impedance | $108.2^{\circ} \mathrm{C} / \mathrm{W}$ (LFCSP) |
|  | $121^{\circ} \mathrm{C} / \mathrm{W}$ (TQFP) |
| $\theta_{\mathrm{sc}}$ Thermal Impedance | $32.71^{\circ} \mathrm{C} / \mathrm{W}$ (LFCSP) |
|  | $45^{\circ} \mathrm{C} / \mathrm{W}$ (TQFP) |
| Lead Temperature, Soldering |  |
| Reflow Temperature (10 sec to 30 sec ) | $255^{\circ} \mathrm{C}$ |
| ESD | 2 kV |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{1}$ Transient currents of up to 100 mA will not cause SCR latch-up.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## PIN FUNCTION DESCRIPTION



Table 5. Pin Function Description

| $\begin{aligned} & \text { Pin } \\ & \text { No } \end{aligned}$ | Mnemonic | Function |
| :---: | :---: | :---: |
| $\begin{aligned} & 1 \text { to } \\ & 8 \end{aligned}$ | DB0 to DB7 | Data Bits 0 to 7. Three-state parallel digital I/O pins that provide the conversion result and also allow the control and shadow registers to be programmed. These pins are controlled by $\overline{C S}, \overline{R D}$, and $\overline{W R}$. The logic high/low voltage levels for these pins are determined by the $V_{\text {DRIVE }}$ input. When reading from the AD7939, the two LSBs (DBO and DB1) are always 0 and the LSB of the conversion result is available on DB2. |
| 9 | $V_{\text {DRIVE }}$ | Logic Power Supply Input. The voltage supplied at this pin determines at what voltage the parallel interface of the AD7938/AD7939 operates. This pin should be decoupled to DGND. The voltage at this pin may be different to that at $V_{D D}$ but should never exceed $V_{D D}$ by more than 0.3 V . |
| 10 | DGND | Digital Ground. This is the ground reference point for all digital circuitry on the AD7938/AD7939. This pin should connect to the DGND plane of a system. The DGND and AGND voltages should ideally be at the same potential and must not be more than 0.3 V apart, even on a transient basis. |
| 11 | DB8/HBEN | Data Bit 8/High Byte Enable. When W/B is high, this pin acts as Data Bit 8, a three-state I/O pin that is controlled by $\overline{C S}$ ,$\overline{\mathrm{RD}}$, and $\overline{\mathrm{WR}}$. When $\mathrm{W} / \overline{\mathrm{B}}$ is low, this pin acts as the high byte enable pin. When HBEN is low, the low byte of data being written to or read from the AD7938/AD7939 is on DB0 to DB7. When HBEN is high, the top four bits of the data being written to or read from the AD7938/AD7939 are on DB0 to DB3. When reading from the device, DB4 to DB6 of the high byte will contain the ID of the channel for which the conversion result corresponds (see the channel address bits in Table 9). When writing to the device, DB4 to DB7 of the high byte must be all 0s. Note that when reading from the AD7939, the two LSBs of the low byte are 0s, and the remaining 6 bits, conversion data. |
| 12 to 14 | $\begin{aligned} & \text { DB9 to } \\ & \text { DB11 } \end{aligned}$ | Data Bits 9 to 11. Three-state parallel digital I/O pins that provide the conversion result and also allow the control and shadow registers to be programmed in word mode. These pins are controlled by $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}$, and $\overline{\mathrm{WR}}$. The logic high/low voltage levels for these pins are determined by the V VRive input. |
| 15 | BUSY | Busy Output. Logic output indicating the status of the conversion. The BUSY output goes high following the falling edge of CONVST and stays high for the duration of the conversion. Once the conversion is complete and the result is available in the output register, the BUSY output goes low. The track-and-hold returns to track mode just prior to the falling edge of BUSY on the $13^{\text {th }}$ rising edge of SCLK, see Figure 38. |
| 16 | CLKIN | Master Clock Input. The clock source for the conversion process is applied to this pin. Conversion time for the AD7938/AD7939 takes 13.5 clock cycles. The frequency of the master clock input therefore determines the conversion time and achievable throughput rate. The CLKIN signal may be a continuous or burst clock. |
| 17 | $\overline{\text { CONVST }}$ | Conversion Start Input. A falling edge on CONVST is used to initiate a conversion. The track-and-hold goes from track to hold mode on the falling edge of CONVST and the conversion process is initiated at this point. Following power-down, when operating in auto-shutdown or auto-standby modes, a rising edge on $\overline{\text { CONVST }}$ is used to power-up the device. |
| 18 | $\overline{\mathrm{WR}}$ | Write Input. Active low logic input used in conjunction with $\overline{\mathrm{CS}}$ to write data to the internal registers. |
| 19 | $\overline{\mathrm{RD}}$ | Read Input. Active low logic input used in conjunction with $\overline{\mathrm{CS}}$ to access the conversion result. The conversion result is placed on the data bus following the falling edge of $\overline{\mathrm{RD}}$ read while $\overline{\mathrm{CS}}$ is low. |
| 20 | $\overline{C S}$ | Chip Select. Active low logic input used in conjunction with $\overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$ to read conversion data or to write data to |


| $\begin{aligned} & \hline \text { Pin } \\ & \text { No } \end{aligned}$ | Mnemonic | Function |
| :---: | :---: | :---: |
|  |  | the internal registers. |
| 21 | AGND | Analog Ground. This is the ground reference point for all analog circuitry on the AD7938/AD7939. All analog input signals and any external reference signal should be referred to this AGND voltage. The AGND and DGND voltages should ideally be at the same potential and must not be more than 0.3 V apart, even on a transient basis. |
| 22 | $V_{\text {Refin }} / V_{\text {ReFout }}$ | Reference Input/Output. This pin is connected to the internal reference and is the reference source for the ADC. The nominal internal reference voltage is 2.5 V and this appears at this pin. This pin can be overdriven by an external reference. The input voltage range for the external reference is 0.1 V to 3.5 V for the differential mode and is 0.1 V to $V_{D D}$ for the single-ended and pseudo-differential modes, depending on $V_{D D}$. |
| $\begin{aligned} & 23 \\ & \text { to } \\ & 30 \end{aligned}$ | $\mathrm{V}_{1 \times} 0$ to $\mathrm{V}_{\text {IN }} 7$ | Analog Input 0 to Analog Input 7. Eight analog input channels that are multiplexed into the on-chip track-and-hold. The analog inputs can be programmed to be eight single-ended inputs, four fully differential pairs, four pseudodifferential pairs, or seven pseudo-differential inputs by setting the MODE bits in the control register appropriately (see Table 9). The analog input channel to be converted can either be selected by writing to the address bits (ADD2 to ADDO) in the control register prior to the conversion or the on-chip sequencer can be used. The SEQ and SHDW bits in conjunction with the address bits in the control register allow the shadow register to be programmed. The input range for all input channels can either be 0 V to $\mathrm{V}_{\text {REF }}$ or 0 V to $2 \times \mathrm{V}_{\text {REF }}$, and the coding can be binary or twos complement, depending on the states of the RANGE and CODING bits in the control register. Any unused input channels should be connected to AGND to avoid noise pickup. |
| 31 | VDD | Power Supply Input. The VDD range for the AD7938/AD7939 is 2.7 V to 5.25 V . The supply should be decoupled to AGND with a $0.1 \mu \mathrm{~F}$ capacitor and a $10 \mu \mathrm{~F}$ tantalum capacitor. |
| 32 | W/B | Word/Byte Input. When this input is logic high, data is transferred to and from the AD7938/AD7939 in 12-bit/10-bit words on Pins DB0/DB2 to DB11. When this pin is logic low, byte transfer mode is enabled. Data and the channel ID are transferred on Pins DB0 to DB7, and Pin DB8/HBEN assumes its HBEN functionality. |

## TERMINOLOGY

## Integral Nonlinearity

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, a point 1 LSB below the first code transition, and full scale, a point 1 LSB above the last code transition.

## Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Offset Error

This is the deviation of the first code transition ( $00 \ldots 000$ ) to ( $00 \ldots 001$ ) from the ideal, i.e., AGND + 1 LSB.

## Offset Error Match

This is the difference in offset error between any two channels.

## Gain Error

This is the deviation of the last code transition (111 ...110) to ( $111 \ldots 111$ ) from the ideal (i.e., $V_{\text {ref }}-1$ LSB) after the offset error has been adjusted out.

## Gain Error Match

This is the difference in gain error between any two channels.

## Zero-Code Error

This applies when using the twos complement output coding option, in particular to the $2 \times \mathrm{V}_{\text {REF }}$ input range with $-\mathrm{V}_{\text {REF }}$ to $+\mathrm{V}_{\text {Ref }}$ biased about the $\mathrm{V}_{\text {Refin }}$ point. It is the deviation of the mid scale transition (all 0 s to all 1s) from the ideal $V_{\text {IN }}$ voltage, i.e., $V_{\text {Ref }}$

## Zero-Code Error Match

This is the difference in zero-code error between any two channels.

## Positive Gain Error

This applies when using the twos complement output coding option, in particular to the $2 \times \mathrm{V}_{\text {ref }}$ input range with $-\mathrm{V}_{\text {ref }}$ to $+\mathrm{V}_{\text {ref }}$ biased about the $\mathrm{V}_{\text {refin }}$ point. It is the deviation of the last code transition ( $011 . . .110$ ) to ( 011 .. . 111) from the ideal (i.e., $+\mathrm{V}_{\text {ref }}-1 \mathrm{LSB}$ ) after the zero-code error has been adjusted out.

## Positive Gain Error Match

This is the difference in positive gain error between any two channels.

## Negative Gain Error

This applies when using the twos complement output coding option, in particular to the $2 \times \mathrm{V}_{\text {ref }}$ input range with $-\mathrm{V}_{\text {ref }}$ to $+V_{\text {REF }}$ biased about the $V_{\text {ReF }}$ point. It is the deviation of the first code transition ( $100 \ldots 000$ ) to ( $100 \ldots 001$ ) from the ideal (i.e., $-V_{\text {refin }}+1$ LSB) after the zero-code error has been adjusted out.

## Negative Gain Error Match

This is the difference in negative gain error between any two channels.

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between channels. It is measured by applying a fullscale sine wave signal to all seven nonselected input channels and applying a 50 kHz signal to the selected channel. The channel-to-channel isolation is defined as the ratio of the power of the 50 kHz signal on the selected channel to the power of the noise signal that appears in the FFT of this channel.

## Power Supply Rejection Ratio (PSRR)

PSRR is defined as the ratio of the power in the ADC output at full-scale frequency, $f$, to the power of a 100 mV p-p sine wave applied to the ADC $V_{D D}$ supply of frequency $f_{s}$. The frequency of the input varies from 1 kHz to 1 MHz .

$$
P S R R(\mathrm{~dB})=10 \log \left(P f / P f_{s}\right)
$$

$P f$ is the power at frequency $f$ in the ADC output; $P f_{s}$ is the power at frequency $f_{s}$ in the ADC output.

## Track-and-Hold Acquisition Time

The track-and-hold amplifier returns into track mode at the end of conversion. The track-and-hold acquisition time is the time required for the output of the track-and-hold amplifier to reach its final value, within $\pm 1 / 2$ LSB, after the end of conversion.

## Signal-to-(Noise + Distortion) Ratio (SINAD)

This is the measured ratio of signal-to-(noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$ ), excluding dc. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal-to-(noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by

$$
\text { Signal-to- }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) \mathrm{dB}
$$

Thus, for a 12-bit converter, this is 74 dB , and for a 10 -bit converter, this is 62 dB .

## Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of harmonics to the fundamental. For the AD7938/ AD7939, it is defined as

$$
T H D(\mathrm{~dB})=-20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $V_{4}, V_{5}$, and $V_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{s}} / 2$ and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$ where $m, n=0,1,2,3$, etc. Intermodulation distortion terms are those for which neither $m$ nor $n$ are equal to 0 . For example, the second-order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), while the third-order terms include $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and $(\mathrm{fa}$ -2 fb ).

The AD7938/AD7939 are tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second-order terms are usually distanced in frequency from the original sine waves while the third-order terms are usually at a frequency close to the input frequencies. As a result, the second- and third-order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in dBs.

## TYPICAL PERFORMANCE CHARACTERISTICS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.


Figure 3. PSRR vs. Supply Ripple Frequency without Supply Decoupling


Figure 4. AD7938 Channel-to-Channel Isolation


Figure 5. AD7938 SINAD vs. Analog Input Frequency for Various Supply Voltages


Figure 6. AD7938 FFT@ VDD $=5 \mathrm{~V}$


Figure 7. AD7938 Typical DNL @ VDD $=5$ V


Figure 8. AD7938 Typical INL @ VDD=5V


Figure 9. $A D 7938$ Change in INL vs. $V_{\text {REF }}$ for $V_{D D}=5 \mathrm{~V}$


Figure 10.AD7938 Change in DNL vs. $V_{R E F}$ for $V_{D D}=5 \mathrm{~V}$


Figure 11. $A D 7938$ Change in $E N O B$ vs. $V_{R E F}$ for $V_{D D}=5 \mathrm{~V}$


Figure 12. AD7938 Offset vs. VREF


Figure 13. AD7938 Histogram of Codes @ VDD $=5$ V with the Internal Reference


Figure 14. AD7938 Histogram of Codes @ VDD $=5$ V with an External Reference


Figure 15. AD7939 FFT @ VD $=5 \mathrm{~V}$


Figure 16. AD7939 Typical DNL @ $V_{D D}=5 \mathrm{~V}$

## ON-CHIP REGISTERS

The AD7938/AD7939 have two on-chip registers that are necessary for the operation of the device. These are the control register, which is used to set up different operating conditions, and the shadow register, which is used to program the analog input channels to be converted.

## CONTROL REGISTER

The control register on the AD7938/AD7939 is a 12-bit, write-only register. Data is written to this register using the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ pins. The control register is shown below and the functions of the bits are described in Table 7. At power up, the default bit settings in the control register are all 0 s .

Table 6. Control Register Bits

| MSB |  |  |  |  |  |  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | 33 | D2 | D1 | D0 |
| PM1 | PM0 | CODING | REF | ADD2 | ADD1 | ADD0 | MODE1 | MODE0 | SHDW | SEQ | RANGE |

Table 7. Control Register Bit Function Description

| Bit No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 11, 10 | PM1, PMO | Power Management Bits. These two bits are used to select the power mode of operation. The user can choose between either normal mode or various power-down modes of operation as shown in Table 8. |
| 9 | CODING | This bit selects the output coding of the conversion result. If this bit is set to 0 , the output coding is straight (natural) binary. If this bit is set to 1 , the output coding is twos complement. |
| 8 | REF | This bit selects whether the internal or external reference is used to perform the conversion. If this bit is Logic 0 , an external reference should be applied to the $V_{\text {REF }}$ pin, and if this bit is Logic 1 , the internal reference is selected (see the Reference Section). |
| 7 to 5 | ADD2 to ADD0 | These three address bits are used to either select which analog input channel is converted in the next conversion if the sequencer is not used or to select the final channel in a consecutive sequence when the sequencer is used as described in Table 10. The selected input channel is decoded as shown in Table 9. |
| 4,3 | MODE1, MODEO | The two mode pins select the type of analog input on the eight $\mathrm{V}_{\text {IN }}$ pins. The AD7938/AD7939 can have either eight single-ended inputs, four fully differential inputs, four pseudo-differential inputs, or seven pseudodifferential inputs (see Table 9). |
| 2 | SHDW | The SHDW bit in the control register is used in conjunction with the SEQ bit to control the sequencer function and access the SHDW register (see Table 10). |
| 1 | SEQ | The SEQ bit in the control register is used in conjunction with the SHDW bit to control the sequencer function and access the SHDW register (see Table 10). |
| 0 | RANGE | This bit selects the analog input range of the AD7938/AD7939. If it is set to 0 , then the analog input range extends from 0 V to $\mathrm{V}_{\text {REF. }}$. If it is set to 1 , then the analog input range extends from 0 V to $2 \times \mathrm{V}_{\text {REF. }}$. When this range is selected, AV VD must be 4.75 V to 5.25 V if a 2.5 V reference is used; otherwise, care must be taken to ensure that the analog input remains within the supply rails. See Analog Inputs section for more information. |

Table 8. Power Mode Selection using the Power Management Bits in the Control Register

| PM1 | PMO | Mode | Description |
| :--- | :--- | :--- | :--- |
| 0 | 0 | Normal <br> Mode | When operating in normal mode, all circuitry is fully powered up at all times. |
| 0 | 1 | Auto <br> Shutdown | When operating in auto-shutdown mode, the AD7938/AD7939 will enter full shutdown mode at the end of <br> each conversion. In this mode, all circuitry is powered down. |
| 1 | 0 | Auto <br> Standby | When the AD7938/AD7939 enter this mode, all circuitry is partially powered down. This mode is similar to <br> auto-shutdown mode, but it allows the part to power-up in $1 \mu$ sec. |
| 1 | 1 | Full <br> Shutdown | When the AD7938/AD7939 enter this mode, all circuitry is powered down. The information in the control <br> register is retained. |

Table 9. Analog Input Type Selection

| Channel Address |  |  | $\text { MODEO }=0, \text { MODE1 }=0$ <br> Eight Single-Ended I/P Channels |  | $\text { MODEO = 0, MODE1 = } 1$ <br> Four Fully Differential I/P Channels |  | $\text { MODE0 = 1, MODE1 = } 0$ <br> Four Pseudo-Differential I/P Channels (Pseudo Mode 1) |  | $\begin{aligned} & \hline \text { MODEO }=1, \text { MODE1 }=1 \\ & \hline \text { Seven Pseudo-Differential I/P } \\ & \text { Channels (Pseudo Mode 2) } \end{aligned}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |  |  |  |
| ADD2 | ADD1 | ADDO | $\mathrm{V}_{1 \mathrm{~N}+}$ | $\mathrm{V}_{\text {IN- }}$ | $\mathbf{V}_{\text {IN+ }}$ | $\mathrm{V}_{\text {IN }}$ - | $\mathrm{V}_{\text {IN+ }}$ | $\mathrm{V}_{\text {In }}$ - | $\mathrm{V}_{\mathbf{I N +}}$ | $\mathrm{V}_{\mathrm{IN} \text { - }}$ |
| 0 | 0 | 0 | VINO | AGND | VINO | VIN1 | VINO | VIN1 | VINO | VIN7 |
| 0 | 0 | 1 | VIN1 | AGND | VIN1 | VINO | VIN1 | VINO | VIN1 | VIN7 |
| 0 | 1 | 0 | VIN2 | AGND | VIN2 | VIN3 | VIN2 | VIN3 | VIN2 | VIN7 |
| 0 | 1 | 1 | VIN3 | AGND | VIN3 | VIN2 | VIN3 | VIN2 | VIN3 | VIN7 |
| 1 | 0 | 0 | VIN4 | AGND | VIN4 | VIN5 | VIN4 | VIN5 | VIN4 | VIN7 |
| 1 | 0 | 1 | VIN5 | AGND | VIN5 | VIN4 | VIN5 | VIN4 | VIN5 | VIN7 |
| 1 | 1 | 0 | VIN6 | AGND | VIN6 | VIN7 | VIN6 | VIN7 | VIN6 | VIN7 |
| 1 | 1 | 1 | VIN7 | AGND | VIN7 | VIN6 | VIN7 | VIN6 | Not |  |

## SEQUENCER OPERATION

The configuration of the SEQ and SHDW bits in the control register allows the user to select a particular mode of operation of the sequencer function. Table 10 outlines the four modes of operation of the sequencer.

Table 10. Sequence Selection

| SEQ | SHDW | Sequence Type |
| :--- | :--- | :--- |
| 0 | 0 | This configuration is selected when the sequence function is not used. The analog input channel selected on each <br> individual conversion is determined by the contents of the channel address bits, ADD2 to ADD0, in each prior write <br> operation. This mode of operation reflects the traditional operation of a multichannel ADC, without the sequencer <br> function being used, where each write to the AD7938/AD7939 selects the next channel for conversion. |
| 0 | 1 | This configuration selects the shadow register for programming. The following write operation loads the data on DB0 to <br> DB7 to the shadow register. This will program the sequence of channels to be converted continuously after each CONVST <br> falling edge (see the shadow register description and Table 11). |
| 1 | 0 | If the SEQ and SHADOW bits are set in this way, the sequence function is not interrupted upon completion of the WRITE <br> operation. This allows other bits in the control register to be altered between conversions while in a sequence without <br> terminating the cycle. |
| 1 | 1 | This configuration is used in conjunction with the channel address bits (ADD2 to ADDO) to program continuous <br> conversions on a consecutive sequence of channels from Channel 0 through to a selected final channel as determined by <br> the channel address bits in the control register. |

## SHADOW REGISTER

The shadow register on the AD7938/AD7939 is an 8-bit, write-only register. Data is loaded from DB0 to DB7 on the rising edge of $\overline{\mathrm{WR}}$. The eight LSBs load into the shadow register. The information is written into the shadow register provided that the SEQ and SHDW bits in the control register were set to 0 and 1, respectively in the previous write to the control register. Each bit represents an analog input from Channel 0 through Channel 7. A sequence of channels may be selected through which the AD7938/AD7939 cycles with each consecutive conversion after the write to the shadow register. To select a sequence of channels to be converted, if operating in singleended mode or Pseudo Mode 2, the associated channel bit in the shadow register must be set for each required analog input. When operating in differential mode or Pseudo Mode 1, the associated pair of channels' bits must be set for each pair of analog inputs required in the sequence. With each consecutive $\overline{\text { CONVST pulse after the sequencer has been set up, the AD7938/AD7939 progress through the }}$ selected channels in ascending order, beginning with the lowest channel. This continues until a write operation occurs with the SEQ and SHDW bits configured in any way except 1,0 (see Table 10). When a sequence is set up in differential or Pseudo Mode 1 , the ADC does not convert on the inverse pairs (i.e., VIN1, VIN0). The bit functions of the shadow register are outlined in Table 11. See the Analog Input Selection section for further information on using the sequencer.

Table 11. Shadow Register Bit Functions

|  |  |  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathbb{N} 0} 0$ | $\mathrm{~V}_{\mathbb{N} 1} 1$ | $\mathrm{~V}_{\mathbb{N} 2}$ | $\mathrm{~V}_{\mathbb{N} 3}$ | $\mathrm{~V}_{\mathbb{N} 4}$ | $\mathrm{~V}_{\mathbb{N} 5}$ | $\mathrm{~V}_{\mathbb{N} 6}$ | $\mathrm{~V}_{\mathbb{N} 7}$ |

## CIRCUIT INFORMATION

The AD7938/AD7939 are fast, 8 -channel, 12 -bit and 10-bit, single-supply, successive approximation analog-to-digital converters. The parts can operate from a 2.7 V to 5.25 V power supply and feature throughput rates up to 1.5 MSPS.

The AD7938/AD7939 provide the user with an on-chip track-and-hold, an accurate internal reference, an analog-to-digital converter, and a parallel interface housed in a 32 -lead LFCSP or TQFP package.

The AD7938/AD7939 have eight analog input channels that can be configured to be eight single-ended inputs, four fully differential pairs, four pseudo-differential pairs, or seven pseudo-differential inputs with respect to one common input. There is an on-chip user-programmable channel sequencer that allows the user to select a sequence of channels through which the ADC can progress and cycle with each consecutive falling edge of CONVST.

The analog input range for the AD7938/AD7939 is 0 to $\mathrm{V}_{\text {ref }}$ or 0 to $2 \times V_{\text {ref }}$ depending on the status of the RANGE bit in the control register. The output coding of the ADC can be either binary or twos complement, depending on the status of the CODING bit in the control register.

The AD7938/AD7939 provide flexible power management options to allow the user to achieve the best power performance for a given throughput rate. These options are selected by programming the power management bits, PM1 and PM0, in the control register.

## CONVERTER OPERATION

The AD7938/AD7939 is a successive approximation ADC based around two capacitive DACs. Figure 18 and Figure 19 show simplified schematics of the ADC in acquisition and conversion phase, respectively. The ADC comprises of control logic, a SAR, and two capacitive DACs. Both figures show the operation of the ADC in differential/pseudo-differential mode. Single-ended mode operation is similar but $\mathrm{V}_{\text {IN- }}$ is internally tied to AGND. In acquisition phase, SW3 is closed, SW1 and SW2 are in Position A, the comparator is held in a balanced condition, and the sampling capacitor arrays acquire the differential signal on the input.


When the ADC starts a conversion (Figure 19), SW3 opens and SW1 and SW2 moves to Position B, causing the comparator to become unbalanced. Both inputs are disconnected once the conversion begins. The control logic and the charge redistribution DACs are used to add and subtract fixed amounts of charge from the sampling capacitor arrays to bring the comparator back into a balanced condition. When the comparator is rebalanced, the conversion is complete. The control logic generates the ADC's output code. The output impedances of the sources driving the $\mathrm{V}_{\text {IN }}+$ and the $\mathrm{V}_{\text {IN }}$ pins must be matched; otherwise, the two inputs will have different settling times, which results in errors.


Figure 19. ADC Conversion Phase

## ADC TRANSFER FUNCTION

The output coding for the AD7938/AD7939 is either straight binary or twos complement, depending on the status of the CODING bit in the control register. The designed code transitions occur at successive LSB values (i.e., 1 LSB, 2 LSBs, and so on) and the LSB size is $V_{\text {ReF }} / 4096$ for the AD7938 and $\mathrm{V}_{\text {Ref }} / 1024$ for the AD7939. The ideal transfer characteristics of the AD7938/AD7939 for both straight binary and twos complement output coding are shown in Figure 20 and Figure 21, respectively.


Figure 20. AD7938/AD7939 Ideal Transfer Characteristic with Straight Binary Output Coding

Figure 18. ADC Acquisition Phase


Figure 21. AD7938/AD7939 Ideal Transfer Characteristic with Twos Complement Output Coding

## TYPICAL CONNECTION DIAGRAM

Figure 22 shows a typical connection diagram for the AD7938/AD7939. The AGND and DGND pins are connected together at the device for good noise suppression. The $\mathrm{V}_{\text {Refin }} / \mathrm{V}_{\text {refout }}$ pin is decoupled to AGND with a $0.47 \mu \mathrm{~F}$ capacitor to avoid noise pickup if the internal reference is used. Alternatively, $V_{\text {refin }} / V_{\text {refout }}$ can be connected to an external reference source, and in this case, the reference pin should be decoupled with a $0.1 \mu \mathrm{~F}$ capacitor. In both cases, the analog input range can either be 0 V to $\mathrm{V}_{\text {ref }}$ (RANGE bit $=0$ ) or 0 V to $2 \times \mathrm{V}_{\text {REF }}($ RANGE bit $=1)$. The analog input configuration can be either eight single-ended inputs, four differential pairs, four pseudo-differential pairs, or seven pseudo-differential inputs (see Table 9). The VDD pin is connected to either a 3 V or 5 V supply. The voltage applied to the $\mathrm{V}_{\text {DRIVE }}$ input controls the voltage of the digital interface and here, it is connected to the same 3 V supply of the microprocessor to allow a 3 V logic interface (see the Digital Inputs section).


Figure 22. Typical Connection Diagram

## ANALOG INPUT STRUCTURE

Figure 23 shows the equivalent circuit of the analog input structure of the AD7938/AD7939 in differential/pseudo differential mode. In single-ended mode, $\mathrm{V}_{\text {IN- }}$ is internally tied to AGND. The four diodes provide ESD protection for the analog inputs. Care must be taken to ensure that the analog input signals never exceed the supply rails by more than 300 mV . This causes these diodes to become forward-biased and starts conducting into the substrate. These diodes can conduct up to 10 mA without causing irreversible damage to the part.

The C 1 capacitors, in Figure 23, are typically 4 pF and can primarily be attributed to pin capacitance. The resistors are lumped components made up of the on resistance of the switches. The value of these resistors is typically about $100 \Omega$. The C2 capacitors are the ADC's sampling capacitors and have a capacitance of 16 pF typically.

For ac applications, removing high frequency components from the analog input signal is recommended by the use of an RC low-pass filter on the relevant analog input pins. In applications where harmonic distortion and signal-to-noise ratio are critical, the analog input should be driven from a low impedance source. Large source impedances significantly affect the ac performance of the ADC. This may necessitate the use of an input buffer amplifier. The choice of the op amp will be a function of the particular application.


Figure 23. Equivalent Analog Input Circuit, Conversion Phase—Switches Open, Track Phase—Switches Closed
When no amplifier is used to drive the analog input, the source impedance should be limited to low values. The maximum source impedance will depend on the amount of THD that can be tolerated. The THD increases as the source impedance increases and performance degrades. Figure 24 shows a graph of the THD versus the analog input signal frequency for different source impedances for both $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ and 3 V .


Figure 24. THD vs. Analog Input Frequency for Various Source Impedances
Figure 25 shows a graph of the THD versus the analog input frequency for various supplies while sampling at 1.5 MHz with an SCLK of 20 MHz . In this case, the source impedance is $10 \Omega$.


Figure 25. THD vs. Analog Input Frequency for Various Supply Voltages

## ANALOG INPUTS

The AD7938/AD7939 have software selectable analog input configurations. The user can choose either eight single-ended inputs, four fully differential pairs, four pseudo-differential pairs, or seven pseudo-differential inputs. The analog input configuration is chosen by setting the MODE0/MODE1 bits in the internal control register (see Table 9).

## Single-Ended Mode

The AD7938/AD7939 can have eight single-ended analog input channels by setting the MODE 0 and MODE1 bits in the control register to 0 . In applications where the signal source has a high impedance, it is recommended to buffer the analog input before applying it to the ADC . The analog input range can be programmed to be either 0 to $V_{\text {ref }}$ or 0 to $2 \times V_{\text {ref. }}$.

If the analog input signal to be sampled is bipolar, the internal reference of the ADC can be used to externally bias up this signal to make it of the correct format for the ADC.

Figure 26 shows a typical connection diagram when operating the ADC in single-ended mode.

*ADDITIONAL PINS OMITTED FOR CLARITY

Figure 26. Single-Ended Mode Connection Diagram

## Differential Mode

The AD7938/AD7939 can have four differential analog input pairs by setting the MODE 0 and MODE1 bits in the control register to 0 and 1 , respectively.

Differential signals have some benefits over single-ended signals, including noise immunity based on the device's common-mode rejection and improvements in distortion performance. Figure 27 defines the fully differential analog input of the AD7938/AD7939.


Figure 27. Differential Input Definition
The amplitude of the differential signal is the difference between the signals applied to the $\mathrm{V}_{\text {IN+ }}$ and $\mathrm{V}_{\text {IN- }}$ pins in each differential pair (i.e., $\mathrm{V}_{\text {IN }+}-\mathrm{V}_{\text {IN-}}$ ). $\mathrm{V}_{\text {IN }+}$ and $\mathrm{V}_{\text {IN- }}$ should be simultaneously driven by two signals each of amplitude $\mathrm{V}_{\text {REF }}$ that are $180^{\circ}$ out of phase (assuming the 0 to $V_{\text {REF }}$ range is selected). The amplitude of the differential signal is therefore $-V_{\text {ref }}$ to $+V_{\text {ref }}$ peak-to-peak (i.e., $2 \times \mathrm{V}_{\text {ref }}$ ). This is regardless of the common mode (CM). The common mode is the average of the two signals, i.e. $\left(\mathrm{V}_{\text {IN }+}+\mathrm{V}_{\mathrm{IN}-}\right) / 2$ and is therefore the voltage that the two inputs are centered on. This results in the span of each input being $\mathrm{CM} \pm \mathrm{V}_{\text {ref }} / 2$. This voltage has to be set up externally and its range varies with $\mathrm{V}_{\text {ref. }}$. As the value of $\mathrm{V}_{\text {ref }}$ increases, the common-mode range decreases. When driving the inputs with an amplifier, the actual common-mode range is determined by the amplifier's output voltage swing.

Figure 28 and Figure 29 show how the common-mode range typically varies with $V_{\text {ref }}$ for a 5 V power supply using the 0 to $V_{\text {ref }}$ range or $2 \times V_{\text {ref }}$ range, respectively. The common mode must be in this range to guarantee the functionality of the AD7938/AD7939.

When a conversion takes place, the common mode is rejected resulting in a virtually noise free signal of amplitude $-\mathrm{V}_{\text {REF }}$ to $+\mathrm{V}_{\text {REF }}$ corresponding to the digital codes of 0 to 4096 for the AD7938 and 0 to 1024 for the AD7939. If the $2 \times V_{\text {REF }}$ range was used then the input signal amplitude would extend from $-2 V_{\text {REF }}$ to $+2 \mathrm{~V}_{\text {ReF }}$ after conversion.


Figure 28. Input Common-Mode Range vs. $V_{\text {REF }}$ ( 0 to $V_{\text {REF }}$ Range, $V_{D D}=5 \mathrm{~V}$ )


Figure 29. Input Common-Mode Range vs. $V_{\text {REF }}\left(2 \times V_{\text {REF }}\right.$ Range, $\left.V_{D D}=5 \mathrm{~V}\right)$

## Driving Differential Inputs

Differential operation requires that $\mathrm{V}_{\text {IN }+}$ and $\mathrm{V}_{\text {IN-}}$ be simultaneously driven with two equal signals that are $180^{\circ}$ out of phase. The common mode must be set up externally and has a range that is determined by $V_{\text {ref }}$, the power supply, and the particular amplifier used to drive the analog inputs. Differential modes of operation with either an ac or dc input provide the best THD performance over a wide frequency range. Since not all applications have a signal preconditioned for differential operation, there is often a need to perform single-ended-todifferential conversion.

## Using an Op Amp Pair

An op amp pair can be used to directly couple a differential signal to one of the analog input pairs of the AD7938/AD7939. The circuit configurations shown in Figure 30 and Figure 31 show how a dual op amp can be used to convert a single-ended signal into a differential signal for both a bipolar and unipolar input signal, respectively.

The voltage applied to Point A sets up the common-mode voltage. In both diagrams, it is connected in some way to the reference, but any value in the common-mode range can be input here to set up the common mode. A suitable dual op amp that could be used in this configuration to provide differential drive to the AD7938/AD7939 is the AD8022.

Take care when choosing the op amp; the selection depends on the required power supply and system performance objectives. The driver circuits in Figure 30 and Figure 31 are optimized for dc coupling applications requiring best distortion performance.

The circuit configuration shown in Figure 30 converts a unipolar, single-ended signal into a differential signal.

The differential op amp driver circuit in Figure 31 is configured to convert and level shift a single-ended, ground-referenced (bipolar) signal to a differential signal centered at the $\mathrm{V}_{\text {ref }}$ level of the ADC.


Figure 30. Dual Op Amp Circuit to Convert a Single-Ended Unipolar Signal into a Differential Signal


Figure 31. Dual Op Amp Circuit to Convert a Single-Ended Bipolar Signal into a Differential Unipolar Signal

## Pseudo-Differential Mode

The AD7938/AD7939 can have four pseudo-differential pairs (Pseudo Mode 1) or seven pseudo differential inputs (Pseudo Mode 2) by setting the MODE0 and MODE1 bits in the control register to 1,0 and 1,1 , respectively. In the case of the four pseudo-differential pairs, $\mathrm{V}_{\text {IN }}+$ is connected to the signal source which must have an amplitude of $V_{\text {REF }}$ to make use of the full dynamic range of the part. A dc input is applied to the $V_{\text {IN- }}$ pin. The voltage applied to this input provides an offset from ground or a pseudo ground for the $\mathrm{V}_{\mathrm{IN}+}$ input. In the case of the seven pseudo-differential inputs, the seven analog input signals inputs are referred to a dc voltage applied to $\mathrm{V}_{\text {IN }} 7$. The benefit of pseudo-differential inputs is that they separate the analog input signal ground from the ADC's ground allowing dc commonmode voltages to be cancelled. Figure 32 shows a connection diagram for pseudo-differential mode.


Figure 32. Pseudo-Differential Mode Connection Diagram

## ANALOG INPUT SELECTION

As shown in Table 9, the user can set up their analog input configuration by setting the values in the MODE0 and MODE1 bits in the control register. Assuming the configuration has been chosen, there are different ways of selecting the analog input to be converted depending on the state of the SEQ and SHDW bits in the control register.

## Traditional Multichannel Operation (SEQ = SHDW =0)

Any one of eight analog input channels or four pairs of channels may be selected for conversion in any order by setting the SEQ and SHDW bits in the control register to 0 . The channel to be converted is selected by writing to the address bits, ADD2 to ADD0, in the control register to program the multiplexer prior to the conversion. This mode of operation is of a traditional multichannel ADC where each data write selects the next channel for conversion. Figure 33 shows a flow chart of this mode of operation. The channel configurations are shown in Table 9.


Figure 33. Traditional Multichannel Operation Flow Chart
Using the Sequencer: Programmable Sequence (SEQ = 0, SHDW = 1 )
The AD7938/AD7939 may be configured to automatically cycle through a number of selected channels using the on-chip programmable sequencer by setting SEQ $=0$ and SHDW $=1$ in the control register. The analog input channels to be converted are selected by setting the relevant bits in the shadow register to 1 , see Table 11.

Once the shadow register has been programmed with the required sequence, the next conversion executed is on the lowest channel programmed in the SHDW register. The next conversion executed will be on the next highest channel in the sequence and so on. When the last channel in the sequence is converted, the internal multiplexer returns to the first channel selected in the shadow register and commences the sequence again.

It is not necessary to write to the control register again once a sequencer operation has been initiated. The $\overline{\mathrm{WR}}$ input must be kept high to ensure that the control register is not accidentally overwritten or that a sequence operation is not interrupted. If the control register is written to at any time during the sequence, then ensure that the SEQ and SHDW bits are set to 1 , 0 to avoid interrupting the conversion sequence. The sequence program remains in force until such time as the AD7938/AD7939 is written to and the SEQ and SHDW bits are configured with any bit combination except 1,0 . Figure 34 shows a flow chart of the programmable sequence operation.


Figure 34. Programmable Sequence Flow Chart
Consecutive Sequence (SEQ = 1, SHDW = 1)
A sequence of consecutive channels can be converted beginning with Channel 0 and ending with a final channel selected by writing to the ADD2 to ADD0 bits in the control register. This is done by setting the SEQ and SHDW bits in the control register to 1 . In this mode, the sequencer can be used without having to write to the shadow register. Once the control register is written to, to set this mode up, the next conversion is on Channel 0 , then Channel 1, and so on until the channel selected by the address bits (ADD2 to ADD0) is reached. The cycle begins again provided the $\overline{\mathrm{WR}}$ input is tied high. If low, the SEQ and SHDW bits must be set to 1,0 to allow the ADC to continue its preprogrammed sequence uninterrupted. Figure 35 shows the flow chart of the consecutive sequence mode.


Figure 35. Consecutive Sequence Mode Flow Chart

## REFERENCE SECTION

The AD7938/AD7939 can operate with either the on-chip or external reference. The internal reference is selected by setting the REF bit in the internal control register to 1. A block diagram of the internal reference circuitry is shown in Figure 36. The internal reference circuitry includes an on-chip 2.5 V band gap reference and a reference buffer. When using the internal reference, the $\mathrm{V}_{\text {refin }} / \mathrm{V}_{\text {refout }}$ pin should be decoupled to AGND with a $0.47 \mu \mathrm{~F}$ capacitor. This internal reference not only provides the reference for the analog-to-digital conversion, but it can also be used externally in the system. It is recommended that the reference output is buffered using an external precision op amp before applying it anywhere in the system.


Figure 36. Internal Reference Circuit Block Diagram
Alternatively, an external reference can be applied to the $\mathrm{V}_{\text {refin }} / \mathrm{V}_{\text {refout }}$ pin of the AD7938/AD7939. An external reference input is selected by setting the REF bit in the internal control register to 0 . When using an external reference, the $V_{\text {refin }} / V_{\text {refout }}$ pin should be decoupled to AGND with a $0.1 \mu \mathrm{~F}$ capacitor. When operating in differential mode, the external reference input range is 0.1 V to 3.5 V , and in all other analog input modes, the external reference input range is 0.1 V to $\mathrm{V}_{\mathrm{DD}}$. In all cases, the specified reference is 2.5 V .

It is important to ensure that, when choosing the reference value, the maximum analog input range ( $\mathrm{V}_{\text {In max }}$ ) is never greater than $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ to comply with the maximum ratings of the device. In the pseudo-differential modes, the user must ensure that $V_{\text {ref }}+V_{\text {IN }} \leq V_{\text {DD }}$ when using the 0 to $V_{\text {ReF }}$ range, or when using the $2 \times V_{\text {Ref }}$ range that $2 \times V_{\text {Ref }}+V_{\text {IN }} \leq V_{\text {DD }}$.

The following two examples calculate the maximum $V_{\text {ref }}$ input that can be used when operating the AD7938/AD7939 in differential mode, using the 0 to $V_{\text {REF }}$ range with a $V_{D D}$ of 5 V and 3 V , respectively.

## Example 1

$$
\begin{gathered}
V_{I N M A X}=V_{D D}+0.3 \\
V_{I N M A X}=V_{R E F}+V_{\text {REF }} / 2 \\
\text { If } V_{D D}=5 \mathrm{~V} \text {, then } V_{I N M A X}=5.3 \mathrm{~V} .
\end{gathered}
$$

Therefore, $3 \times V_{R E F} / 2=5.3 \mathrm{~V}$.

$$
V_{\text {REF } \operatorname{MAX}}=3.5 \mathrm{~V}
$$

Therefore, when operating at $V_{D D}=5 \mathrm{~V}$, the value of $V_{\text {REF }}$ can range from 100 mV to a maximum value of 3.5 V . When $V_{D D}=$ $4.75 \mathrm{~V}, V_{\text {Ref }} \max =3.17 \mathrm{~V}$.

## Example 2

$$
\begin{aligned}
& V_{I N M A X}=V_{D D}+0.3 \\
& V_{I N M A X}=V_{\text {REF }}+V_{\text {REF }} / 2
\end{aligned}
$$

If $V_{D D}=3.6 \mathrm{~V}$, then $V_{I N M A X}=3.9 \mathrm{~V}$.
Therefore, $3 \times V_{R E F} / 2=3.6 \mathrm{~V}$.

$$
V_{\text {REF MAX }}=2.6 \mathrm{~V}
$$

Therefore, when operating with at $V_{D D}=3 \mathrm{~V}$, the value of $V_{R E F}$ can range from 100 mV to a maximum value of 2.4 V . When $V_{D D}=2.7 \mathrm{~V}, V_{\text {Ref }}$ maX $=2 \mathrm{~V}$.

These examples show that the maximum reference applied to the AD7938/AD7939 is directly dependant on the value applied to $\mathrm{V}_{\mathrm{DD}}$.

The performance of the part at different reference values is shown in Figures TBD to TBD. The value of the reference sets the analog input span and the common-mode voltage range. Errors in the reference source result in gain errors in the AD7938/AD7939 transfer function and add to specified fullscale errors on the part.

Table 12 lists examples of suitable voltage references that could be used that are available from Analog Devices and Figure 37 shows a typical connection diagram for an external reference.
Table 12. Examples of Suitable Voltage References

| Reference | Output <br> Voltage | Initial Accuracy <br> $(\%$ Max) | Operating <br> Current $(\boldsymbol{\mu A})$ |
| :--- | :--- | :--- | :--- |
| AD780 | $2.5 / 3$ | 0.04 | 1000 |
| ADR421 | 2.5 | 0.04 | 500 |
| ADR420 | 2.048 | 0.05 | 500 |



Figure 37. Typical VREF Connection Diagram

## Digital Inputs

The digital inputs applied to the AD7938/AD7939 are not limited by the maximum ratings that limit the analog inputs. Instead, the digital inputs applied can go to 7 V and are not restricted by the $A V_{D D}+0.3 \mathrm{~V}$ limit as on the analog inputs.

Another advantage of the digital inputs not being restricted by the $A V_{D D}+0.3 \mathrm{~V}$ limit is the fact that power supply sequencing issues are avoided. If any of these inputs are applied before $A V_{\mathrm{DD}}$, then there is no risk of latch-up as there would be on the analog inputs if a signal greater than 0.3 V was applied prior to $A V_{\text {DD }}$.

## $V_{\text {DRIVE }}$ Input

The AD7938/AD7939 has a $V_{\text {DRIVE }}$ feature. $V_{\text {DRIVE }}$ controls the voltage at which the parallel interface operates. V $\mathrm{V}_{\text {dive }}$ allows the ADC to easily interface to 3 V and 5 V processors.

For example, if the AD7938/AD7939 operate with an $A V_{D D}$ of 5 V and the $\mathrm{V}_{\text {DRIVE }}$ pin is powered from a 3 V supply, the AD7938/AD7939 has better dynamic performance with an AV DD of 5 V while still being able to interface directly to 3 V processors. Care should be taken to ensure $V_{\text {DRIVE }}$ does not exceed $\mathrm{AV}_{\mathrm{DD}}$ by more than 0.3 V (see the Absolute Maximum Ratings section).

## PARALLEL INTERFACE

The AD7938/AD7939 have a flexible, high speed, parallel interface. This interface is 12 -bits (AD7938) or 10-bits (AD7939) wide and is capable of operating in either word (W/B tied high) or byte (W/B tied low) mode. The $\overline{\mathrm{CONVST}}$ signal is used to initiate conversions on the ADC, and when operating in auto-shutdown or auto-standby mode, it is used to power up the device.

A falling edge on the $\overline{\text { CONVST }}$ signal is used to initiate conversions and it also puts the ADC track-and-hold into track. Once the $\overline{\text { CONVST }}$ signal goes low, the BUSY signal goes high for the duration of the conversion. In between conversions, $\overline{\text { CONVST }}$ must be brought high for a minimum time of $t_{1}$. This must happen after the $14^{\text {th }}$ rising edge of CLKIN; otherwise, the
conversion is aborted and the track-and-hold goes back into track. At the end of the conversion, BUSY goes low and can be used to activate an interrupt service routine. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ lines are then activated in parallel to read the 12- or 10 - bits of conversion data. When power supplies are first applied to the device, a rising edge on $\overline{\text { CONVST }}$ puts the track-and-hold into track. The acquisition time of 135 ns minimum must be allowed before $\overline{\mathrm{CONVST}}$ is brought low to initiate a conversion. The ADC then goes into hold on the falling edge of $\overline{\text { CONVST }}$ and back into track on the $13^{\text {th }}$ rising edge of CLKIN after this (see Figure 38). When operating the device in auto-shutdown or auto-standby mode, where the ADC powers down at the end of each conversion, a rising edge on the $\overline{\mathrm{CONVST}}$ signal is used to power up the device.


Figure 38. AD7938/AD7939 Parallel Interface—Conversion and Read Cycle in Word Mode ( $W / \bar{B}=1$ )

## Reading Data from the AD7938/AD7939

With the W/B pin tied logic high, the AD7938/AD7939 interface operates in word mode. In this case, a single read operation from the device accesses the conversion data-word on Pins DB0 to DB11. The DB8/HBEN pin assumes its DB8 function. With the W/B pin tied to logic low, the AD7938/AD7939 interface operates in byte mode. In this case, the DB8/HBEN pin assumes its HBEN function. Conversion data from the AD7938/ AD7939 must be accessed in two read operations with 8 bits of data provided on DB0 to DB7 for each of the read operations. The HBEN pin determines whether the read operation accesses the high byte or the low byte of the12or 10-bit word. For a low byte read, DB0 to DB7 provide the eight LSBs of the 12 -bit word. For 10 -bit operation, the two LSBs of the low byte are 0 s and are followed by 6 bits of conversion data. For a high byte read, DB0 to DB4 provide the four MSBs of the 12-/10-bit word. DB5 to DB7 of the high byte provide the Channel ID. Figure 38 shows the read cycle timing diagram for a 12-/10-bit transfer. When operated in word mode, the HBEN input does not exist, and only the first read operation
is required to access data from the device. When operated in byte mode, the two read cycles shown in Figure 39 are required to access the full data-word from the device.

The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals are gated internally and level triggered active low. In either word mode or byte mode, $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ may be tied together as the timing specifications for $t_{10}$ and $t_{11}$ are 0 ns minimum. This would mean the bus would be constantly driven by the AD7938/AD7939.

The data is placed onto the data-bus a time $t_{13}$ after both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ go low. The $\overline{\mathrm{RD}}$ rising edge can be used to latch data out of the device. After a time, $\mathrm{t}_{14}$, the data lines will become threestated.

Alternatively, $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ can be tied permanently low and the conversion data is valid and placed onto the data-bus a time, $\mathrm{t}_{9}$, before the falling edge of BUSY.


Figure 39. AD7938/AD7939 Parallel Interface—Read Cycle Timing for Byte Mode Operation (W/B=0)

## Preliminary Technical Data

## AD7938/AD7939

## Writing Data to the AD7938/AD7939

With $\mathrm{W} / \overline{\mathrm{B}}$ tied logic high, a single write operation transfers the full data-word on DB0 to DB11 to the control register on the AD7938/AD7939. The DB8/HBEN pin assumes its DB8 function. Data written to the AD7938/AD7939 should be provided on the DB0 to DB11 inputs with DB0 being the LSB of the data-word. With W/B tied logic low, the AD7938/AD7939 requires two write operations to transfer a full 12-bit word. DB8/HBEN assumes its HBEN function. Data written to the AD7938/AD7939 should be provided on the DB0 to DB7 inputs. HBEN determines whether the byte written is high byte or low byte data. The low byte of the data-word should be written first with DB0 being the LSB of the full data-word. For the high byte write, HBEN should be high and the data on the DB0 input should be data bit 8 of the 12 -bit word. In both word and byte mode, a single write operation to the shadow register is always sufficient since it is only 8 -bits wide.

AD7938/AD7939. When operated in word mode, the HBEN input does not exist and only the one write operation is required to write the word of data to the device. Data should be provided on DB0 to DB11. When operated in byte mode, the two write cycles shown in Figure 41 are required to write the full dataword to the AD7938/AD7939. In Figure 41, the first write transfers the lower 8 bits of the data-word from DB0 to DB7, and the second write transfers the upper 4 bits of the data-word. When writing to the AD7938/AD7939, the top 4 bits in the high byte must be 0 s.

The data is latched into the device on the rising edge of $\overline{\mathrm{WR}}$. The data needs to be setup a time, $\mathrm{t}_{7}$, before the $\overline{\mathrm{WR}}$ rising edge and held for a time, $\mathrm{t}_{8}$, after the $\overline{\mathrm{WR}}$ rising edge. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ signals are gated internally. $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ may be tied together as the timing specifications for $t_{4}$ and $t_{5}$ are 0 ns minimum (assuming $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ have not already been tied together).

Figure 40 shows the write cycle timing diagram of the


Figure 40. AD7938/AD7939 Parallel Interface—Write Cycle Timing for Word Mode Operation $(W / \bar{B}=1)$


Figure 41. AD7938/AD7939 Parallel Interface—Write Cycle Timing for Byte Mode Operation (W/B=0)

## POWER MODES OF OPERATION

The AD7938/AD7939 have four different power modes of operation. These modes are designed to provide flexible power management options. Different options can be chosen to optimize the power dissipation/throughput rate ratio for differing applications. The mode of operation is selected by the power management bits, PM1 and PM0, in the control register, as detailed in Table 8. When power is first applied to the AD7938/AD7939 an on-chip, power-on reset circuit ensures that the default power-up condition is normal mode.

Note that, after power-on, the track-and-hold is in hold mode and the first rising edge of CONVST places the track-and-hold into track mode.

## Normal Mode (PM1 = PMO = 0 )

This mode is intended for the fastest throughput rate performance because the user does not have to worry about any power-up times associated with the AD7938/AD7939 because it remains fully powered up at all times. At power-on reset, this mode is the default setting in the control register.

## Auto-Shutdown (PM1 = 0; PMO = 1)

In this mode of operation, the AD7938/AD7939 automatically enters full shutdown at the end of each conversion, which is shown at Point A in Figure 38. In shutdown mode, all internal circuitry on the device is powered down. The part retains information in the control register during shutdown. The track-and-hold also goes into hold at this point and remains in hold as long as the device is in shutdown. The AD7938/AD7939 remains in shutdown mode until the next rising edge of CONVST (see Point B in Figure 38). In order to keep the device in shutdown for as long as possible, $\overline{\text { CONVST }}$ should idle low between conversions as shown in Error! Reference source not found.. On this rising edge, the part begins to power-up and track-and-hold returns to track mode. The power-up time required depends on whether the user is operating with the
internal or external reference. With the internal reference, the power-up time is typically TBD, and with an external reference, the power-up time is typically TBD. The user should ensure that the power-up time has elapsed before initiating a conversion.

## Auto-Standby ( $\mathbf{P M 1}=\mathbf{1 ; ~ P M 0}=\mathbf{0}$ )

In this mode of operation, the AD7938/AD7939 automatically enters standby mode at the end of each conversion, which is shown as Point A in Figure 38. When this mode is entered, all circuitry on the AD7938/AD7939 is powered down except for the reference and reference buffer. The track-and-hold goes into hold at this point also and remains in hold as long as the device is in standby. The part remains in standby until the next rising edge of $\overline{\text { CONVST }}$ powers up the device, which takes at least
TBD. The user should ensure this power-up time has elapsed before initiating another conversion as shown in Error!
Reference source not found.. This rising edge of CONVST also places track-and-hold back into track mode.

## Full Shutdown Mode (PM1 = 1; PM0 = 1)

When this mode is programmed, all circuitry on the AD7938/AD7939 is powered down upon completion of the write operation, i.e., on rising edge of $\overline{\mathrm{WR}}$. The part retains the information in the control register while the part is in shutdown. Also, track-and-hold goes into hold mode at this point. The AD7938/AD7939 remains in full shutdown mode and track-and-hold in hold mode, until the power management bits (PM1 and PM0) in the control register are changed. If a write to the control register occurs while the part is in full shutdown mode, and the power management bits are changed to $\mathrm{PM} 0=\underline{\mathrm{PM} 1}=0$, i.e., normal mode, the part begins to powerup on the $\overline{\mathrm{WR}}$ rising edge and the track-and-hold returns to track. To ensure the part is fully powered up before a conversion is initiated, the power-up time, TBD should be allowed before the next $\overline{\text { CONVST }}$ falling edge; otherwise, invalid data will be read.


Figure 42 Auto-Shutdown/Auto-Standby Mode

## POWER VS. THROUGHPUT RATE

A big advantage of powering the ADC down after a conversion is that the power consumption of the part is significantly reduced at lower throughput rates. When using the different power modes, the AD7938/AD7939 is only powered up for the duration of the conversion. Therefore, the average power consumption per cycle is significantly reduced. Figure 43 and Figure 44 show plots of power versus throughput when operating in auto-shutdown and auto-standby modes.


Figure 43. Power vs. Throughput in Auto-Shutdown Mode


Figure 44. Power vs. Throughput in Auto-Standby Mode

## MICROPROCESSOR INTERFACING

 AD7938/AD7939 to ADSP-21xx InterfaceFigure 45 shows the AD7938/AD7939 interfaced to the ADSP21xx series of DSPs as a memory mapped device. A single wait state may be necessary to interface the AD7938/AD7939 to the ADSP-21xx depending on the clock speed of the DSP. The wait state can be programmed via the data memory wait state control register of the ADSP-21xx (please see the ADSP-21xx family User's Manual for details). The following instruction reads from the AD7938/AD7939

$$
\mathrm{MR}=\mathrm{DM}(\mathrm{ADC})
$$

where ADC is the address of the AD7938/AD7939.


Figure 45. Interfacing to the ADSP-21xx

## AD7938/AD7939 to ADSP-21065L Interface

Figure 46 shows a typical interface between the AD7938/AD7939 and the ADSP-21065L SHARC processor. This interface is an example of one of three DMA handshake modes. The $\overline{M S}_{\mathrm{x}}$ control line is actually three memory select lines. Internal $\mathrm{ADDR}_{25-24}$ are decoded into $\overline{\mathrm{MS}_{3-0}}$, these lines are then asserted as chip selects. The $\overline{\text { DMAR }_{1}}$ (DMA request 1 ) is used in this setup as the interrupt to signal the end of conversion. The rest of the interface is standard handshaking operation.

*ADDITIONAL PINS REMOVED FOR CLARITY

## Figure 46. Interfacing to the ADSP-21065L

## AD7938/AD7939 to TMS32020, TMS320C25, and TMS320C5x Interface

Parallel interfaces between the AD7938/AD7939 and the TMS32020, TMS320C25, and TMS320C5x family of DSPs are shown in Figure 47. The memory mapped address chosen for the AD7938/AD7939 should be chosen to fall in the I/O memory space of the DSPs. The parallel interface on the AD7938/AD7939 is fast enough to interface to the TMS32020 with no extra wait states. If high speed glue logic, such as 74AS devices, are used to drive the $\overline{\mathrm{RD}}$ and the $\overline{\mathrm{WR}}$ lines when interfacing to the TMS320C25, then again, no wait states are necessary. However, if slower logic is used, data accesses may be
slowed sufficiently when reading from and writing to the part to require the insertion of one wait state. Extra wait states will be necessary when using the TMS320C5x at their fastest clock speeds (see the TMS320C5x User's Guide for details).

Data is read from the ADC using the following instruction
IN D, ADC
where $D$ is the data memory address and the $A D C$ is the AD7938/AD7939 address.


Figure 47. Interfacing to the TMS32020/C25/C5x

## AD7938/AD7939 to 80C186 Interface

Figure 48 shows the AD7938/AD7939 interfaced to the 80C186 microprocessor. The 80C186 DMA controller provides two independent high speed DMA channels where data transfer can occur between memory and I/O spaces. Each data transfer consumes two bus cycles, one cycle to fetch data and the other to store data. After the AD7938/AD7939 finish a conversion, the BUSY line generates a DMA request to Channel 1 (DRQ1). Because of the interrupt, the processor performs a DMA read operation that also resets the interrupt latch. Sufficient priority must be assigned to the DMA channel to ensure that the DMA request is serviced before the completion of the next conversion.


Figure 48. Interfacing to the 80C186

## APPLICATION HINTS

## GROUNDING AND LAYOUT

The printed circuit board that houses the AD7938/AD7939 should be designed so that the analog and digital sections are separated and confined to certain areas of the board. This facilitates the use of ground planes that can be easily separated. A minimum etch technique is generally best for ground planes as it gives the best shielding. Digital and analog ground planes should be joined in only one place, and the connection should be a star ground point established as close to the ground pins on the AD7938/AD7939 as possible. Avoid running digital lines under the device as this will couple noise onto the die. The analog ground plane should be allowed to run under the AD7938/AD7939 to avoid noise coupling. The power supply lines to the AD7938/AD7939 should use as large a trace as possible to provide low impedance paths and reduce the effects of glitches on the power supply line.

Fast switching signals, such as clocks, should be shielded with digital ground to avoid radiating noise to other sections of the board, and clock signals should never run near the analog inputs. Avoid crossover of digital and analog signals. Traces on opposite sides of the board should run at right angles to each other. This will reduce the effects of feedthrough through the board. A microstrip technique is by far the best but is not always possible with a double-sided board.

In this technique, the component side of the board is dedicated to ground planes, while signals are placed on the solder side.

Good decoupling is also important. All analog supplies should be decoupled with $10 \mu \mathrm{~F}$ tantalum capacitors in parallel with $0.1 \mu \mathrm{~F}$ capacitors to GND. To achieve the best from these decoupling components, they must be placed as close as possible to the device, ideally right up against the device. The $0.1 \mu \mathrm{~F}$ capacitors should have low effective series resistance (ESR) and effective series inductance (ESI), such as the common ceramic types or surface-mount types, which provide a low impedance path to ground at high frequencies to handle transient currents due to internal logic switching.

## PCB DESIGN GUIDELINES FOR CHIP SCALE PACKAGE

The lands on the chip scale package (CP-32) are rectangular. The printed circuit board pad for these should be 0.1 mm longer than the package land length and 0.05 mm wider than the package land width. The land should be centered on the pad. This ensures that the solder joint size is maximized. The bottom of the chip scale package has a thermal pad. The thermal pad on the printed circuit board should be at least as large as this exposed pad. On the printed circuit board, there should be a clearance of at least 0.25 mm between the thermal pad and the inner edges of the pad pattern. This ensures that shorting is avoided. Thermal vias may be used on the printed circuit board thermal pad to improve thermal performance of the package. If vias are used, they should be incorporated in the thermal pad at 1.2 mm pitch grid. The via diameter should be between 0.3 mm and 0.33 mm , and the via barrel should be plated with 1 oz . copper to plug the via. The user should connect the printed circuit board thermal pad to AGND.

## EVALUATING THE AD7938/AD7939 PERFORMANCE

The recommended layout for the AD7938/AD7939 is outlined in the evaluation board documentation. The evaluation board package includes a fully assembled and tested evaluation board, documentation, and software for controlling the board from the PC via the evaluation board controller. The evaluation board controller can be used in conjunction with the AD7938/AD7939 evaluation board, as well as many other ADI evaluation boards ending in the CB designator, to demonstrate/evaluate the ac and dc performance of the AD7938/AD7939.

The software allows the user to perform ac (fast Fourier transform) and dc (histogram of codes) tests on the AD7938/AD7939. The software and documentation are on the CD that ships with the evaluation board.

## OUTLINE DIMENSIONS



Figure 49. 32-Lead Lead Frame Chip Scale Package [LFCSP], (CP-32)—Dimensions shown in millimeters


Figure 50. 32-Lead Thin Plastic Quad Flat Package [TQFP], (SU-32)—Dimensions shown in millimeters

## ORDERING GUIDE

| Model | Temperature <br> Range | Linearity Error (LSB) ${ }^{\mathbf{1}}$ | Package Option | Package Descriptions |
| :--- | :--- | :--- | :--- | :--- |
| AD7938BCP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | $\mathrm{CP}-32$ | LFCSP |
| AD7939BCP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | $\mathrm{CP}-32$ | LFCSP |
| AD7938BSU | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | $\mathrm{SU}-32$ | TQFP |
| AD7939BSU | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | $\mathrm{SU}-32$ |  |
| EVAL-ADxxxCB ${ }^{2}$ | Evaluation Board |  |  |  |
| EVAL-CONTROL BRD2 ${ }^{3}$ | Controller Board |  |  |  |

[^5]${ }^{2}$ This can be used as a stand-alone evaluation board or in conjunction with the Evaluation Board Controller for evaluation/demonstration purposes.
${ }^{3}$ Evaluation Board Controller. This board is a complete unit allowing a PC to control and communicate with all Analog Devices evaluation boards ending in the CB designators. The following needs to be ordered to obtain a complete evaluation kit: the ADC Evaluation Board (EVALADxxxxCB), the EVAL-CONTROL BRD2 and a 12 V ac transformer. See the ADxxxx evaluation board technical note for more details.


[^0]:    Rev. PrN
    Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and

[^1]:    One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
    Tel: 781.329.4700
    www.analog.com
    Fax: 781.326.8703 © 2004 Analog Devices, Inc. All rights reserved.

[^2]:    ${ }^{1}$ Temperature ranges as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2}$ See the Terminology section.
    ${ }^{3}$ Analog inputs with slew rates exceeding $27 \mathrm{~V} / \mu$ (full-scale input sine wave $>3.5 \mathrm{MHz}$ ) within the acquisition time may cause an incorrect result to be returned by the converter.
    ${ }^{4}$ For full common-mode range see Figure 28 and Figure 29.
    ${ }^{5}$ Sample tested during initial release to ensure compliance.
    ${ }^{6}$ This device is operational with an external reference in the range 0.1 V to 3.5 V in differential mode and 0.1 V to V DD in pseudo-differential and single-ended modes.
    See the Reference Section for more information.
    ${ }^{7}$ Measured with a midscale dc input.

[^3]:    ${ }^{1}$ Temperature ranges as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2}$ See the Terminology section.
    ${ }^{3}$ Analog inputs with slew rates exceeding $27 \mathrm{~V} / \mu \mathrm{s}$ (full-scale input sine wave $>3.5 \mathrm{MHz}$ ) within the acquisition time may cause an incorrect conversion result to be returned by the converter.
    ${ }^{4}$ For full common-mode range see Figure 28 and Figure 29.
    ${ }^{5}$ Sample tested during initial release to ensure compliance.
    ${ }^{6}$ This device is operational with an external reference in the range 0.1 V to 3.5 V in differential mode and 0.1 V to $\mathrm{V}_{\mathrm{DD}}$ in pseudo-differential and single-ended modes.
    See the Reference Section for more details.
    ${ }^{7}$ Measured with a midscale dc input.

[^4]:    ${ }^{1}$ Sample tested during initial release to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}$ ( $10 \%$ to $90 \%$ of $\mathrm{V}_{\mathrm{DD}}$ ) and timed from a voltage level of 1.6 V .
    All timing specifications given above are with a 25 pF load capacitance (see Figure 38, Figure 39, Figure 40and Figure 41.
    ${ }^{2}$ Mark/space ratio for CLKIN is 40/60 to 60/40.
    ${ }^{3}$ The time required for the output to cross TBD.
    ${ }^{4} \mathrm{t}_{14}$ is derived from the measured time taken by the data outputs to change 0.5 V . The measured number is then extrapolated back to remove the effects of charging or discharging the 25 pF capacitor. This means that the time, $\mathrm{t}_{14}$, quoted in the timing characteristics is the true bus relinquish time of the part and is independent of the bus loading.

[^5]:    ${ }^{1}$ Linearity error here refers to integral linearity error.

